

# SOD882 Plastic Package **Transient Voltage Suppressors ESD Protection Diode**

**Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

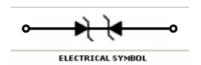
Symbol	Parameter	Value	Units			
PD	Total Power Dissipation on FR-5 Broad	150	mW			
T <sub>L</sub>	Max Lead Solder Temperature range (10 Second Duration)					
$T_J,T_stg$	Junction & Storage Temperature Range	-55 to +150	°C			
$T_{OPR}$	Max operation Temperature Range	+125	°C			
ESD	IEC61000-4-2 Air Discharge Contact Discharge	±25 ±20	KV			

These ratings are limiting values above which the serviceability of the diode may be impaired.

# **Green Product**



SOD882 Package



### **Specification Features:**

Capacitance Max. 16pF

Small Body Outline Dimensions

999999 Low Leakage Current

ESD Rating of Class 3 (>16kV) per Human Body Model

**RoHS Compliant** 

Green EMC

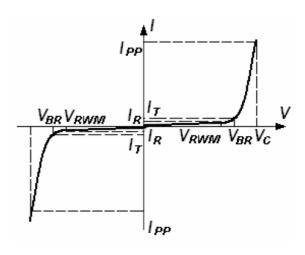
Matte Tin(Sn) Lead Finish

#### **DEVICE MARKING CODES:**

Device Type	Marking	Shipping		
ESD8D3V3CA	ВК	10,000/Reel		

## **Electrical Parameter**

Symbol	Parameter					
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current					
Vc	Clamping Voltage @ I <sub>PP</sub>					
$V_{RWM}$	Working Peak Reverse Voltage					
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>					
I <sub>T</sub>	Test Current					
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>					







Electrical Characteristics	$(T_A = 25^{\circ}C \text{ unless otherwise noted})$
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Device Type	V <sub>RWM</sub> (Volts)	<b>I</b> <sub>R</sub> @ <b>V</b> <sub>RWM</sub> (μΑ)	(No	V <sub>BR</sub> @ I <sub>T</sub> (Note 1) (Volts)	I <sub>T</sub> (mA)	<b>V</b> <sub>C</sub> @ <b>I</b> <sub>PP+</sub> =1A (Volts)	I <sub>PP+</sub> (A)	V <sub>C</sub> @ Max I <sub>PP+</sub> (Volts)	P <sub>PK+</sub> (W)	C @ <b>V</b> <sub>R</sub> = 0V, f = 1MHz (pF)
	Max	Max	Min	Max		Max	Max	Max	Max	Max
ESD8D3V3CA	3.3	0.1	5	6.5	1.0	7	6	10	60	16

<sup>+</sup> Surge current waveform per Figure 1.

Note 1: V<sub>BR</sub> is measured with a pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

### SURGE CURRENT WAVEFORM:

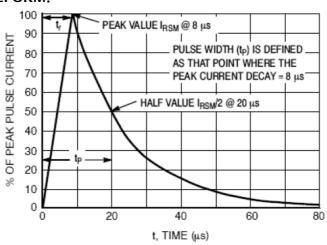
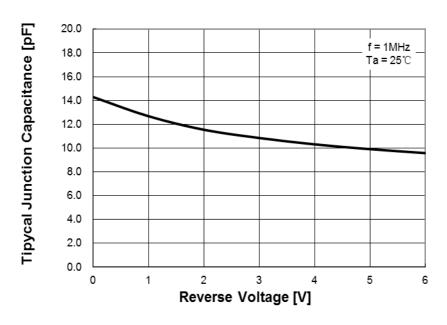


Figure 1. 8 x 20 µs Pulse Waveform

### **CAPACITANCE CURVE:**

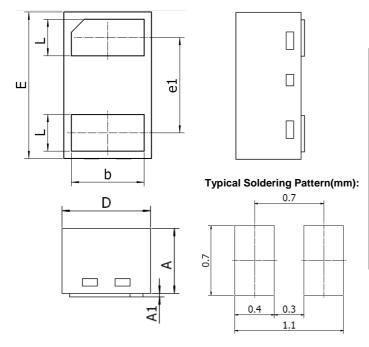


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## **SOD882 Package Outline**



DIM	MILLIM	ETERS	INCHES			
	MIN	MAX	MIN	MAX		
А	0.46	0.50	0.018	0.020		
A1		0.03		0.001		
b	0.45	0.55	0.018	0.022		
D	0.55	0.65	0.022	0.026		
Е	0.95	1.05	0.037	0.041		
e1	Тур.	0.65	Тур.	Тур. 0.026		
L	0.20	0.30	0.008	0.012		



### **NOTICE**

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